2SK3318

Silicon N-channel power MOSFET

For switching

■ Features

- Avalanche energy capability guaranteed
- High-speed switching
- Low ON resistance Ron
- No secondary breakdown

■ Absolute Maximum Ratings $T_C = 25$ °C

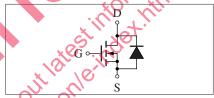
Symbol	Rating	Unit	
V _{DSS}	600	V	
V _{GSS}	±30	V	
I_D	±15	A	
I_{DP}	±60	A	
EAS	112,5	mJ	
P_{D}	100	W	
	3		
T _{ch}	150	°C	
$T_{ m stg}$	-55 to +150	°C	
	V _{DSS} V _{GSS} I _D I _{DP} EAS P _D	$\begin{array}{c cccc} V_{DSS} & 600 \\ \hline V_{GSS} & \pm 30 \\ \hline I_D & \pm 15 \\ \hline I_{DP} & \pm 60 \\ \hline EAS & 112.5 \\ \hline P_D & 100 \\ \hline & 3 \\ \hline T_{ch} & 150 \\ \hline \end{array}$	

Note) *: L = 1 mH, $I_L = 15 A$, 1 pulse

■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

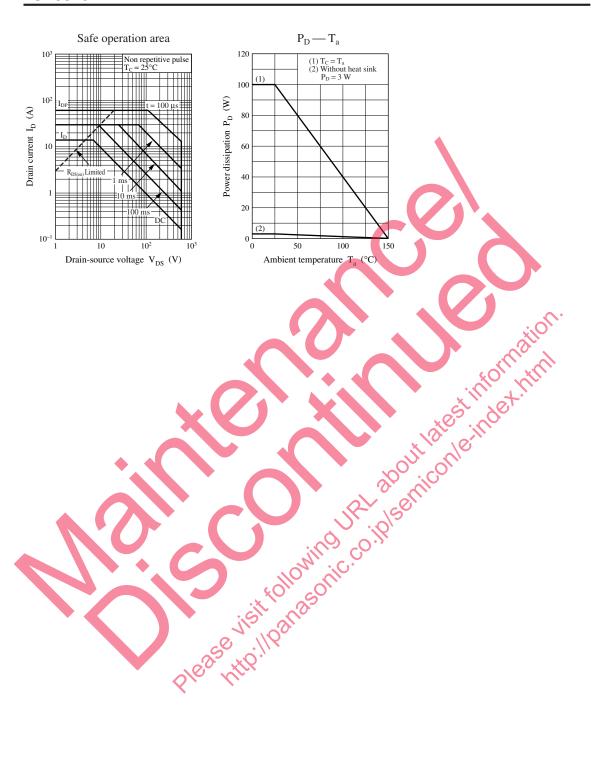
	Unit: mm		
15.0±0.3 11.0±0.2 \$\frac{1}{9}\text{0.0}{\text{0.0}}\text{0.0}{\	5.0±0.2 (3.2) 2.0±0.1		
1 2 3	1: Gate		
2. Drain 3: Source			
TO	P-3F-A1 Package		





Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Gate-drain surrender voltage	V _{DSS}	$I_D = 1 \text{ mA}, V_{GS} = 0$	600			V
Diode forward voltage	$V_{\rm DSF}$	$I_{DR} = 15 \text{ A}, V_{GS} = 0$			-1.5	V
Gate threshold voltage	V _{th}	$V_{DS} = 25 \text{ V}, I_D = 1 \text{ mA}$	2		4	V
Drain-source cutoff current	I_{DSS}	$V_{DS} = 480 \text{ V}, V_{GS} = 0$			10	μΑ
Gate-source cutoff currentt	I_{GSS}	$V_{GS} = \pm 30 \text{ V} \cdot V_{DS} = 0$			±1	μΑ
Drain-source on resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$		0.33	0.46	Ω
Forward transfer admittance	Y _{fs}	$V_{DS} = 25 \text{ V}, I_D = 7.5 \text{ A}$	6	10		S
Short-circuit forward transfer capacitance	Cids	$V_{DS} = 20 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		3 500		pF
(Common-source)	D W	•				
Short-circuit output capacitance	Coss			340		pF
(Common-source)						
Reverse transfer capacitance	C _{rss}			50		pF
(Common-source)						
Turn-on delay time	t _{d(on)}	$V_{DD} = 150 \text{ V}, I_D = 7.5 \text{ A}$		40		ns
Rise time	t _r	$R_{L} = 20 \Omega, V_{GS} = 10 V$		55		ns
Turn-off delay time	t _{d(off)}			310		ns
Fall time	t _f			70		ns
Channel-case heat resistance	R _{th(ch-c)}				1.25	°C/W
Channel-atmosphere heat resistance	R _{th(ch-a)}				41.7	°C/W

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



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